

Certification Report

BSI-DSZ-CC-1149-V2-2023

for

NXP Secure Smart Card Controller N7122 with IC Dedicated Software and Crypto Library (R1/R2/R3)

from

NXP Semiconductors Germany GmbH

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Bundesamt für Sicherheit in der Informationstechnik

Deutsches erteilt vom



IT-Sicherheitszertifikat

Bundesamt für Sicherheit in der Informationstechnik

BSI-DSZ-CC-1149-V2-2023 (*)

Smartcard Controller

NXP Secure Smart Card Controller N7122 with IC Dedicated Software and Crypto Library (R1/R2/R3)

from PP Conformance:	NXP Semiconductors Germany GmbH Security IC Platform Protection Profile with Augmentation Packages Version 1.0, 13 January 2014, BSI-CC-PP-0084-2014	SOGIS Recognition Agreement
Functionality:	PP conformant plus product specific extensions Common Criteria Part 2 extended	
Assurance:	Common Criteria Part 3 conformant EAL 6 augmented by ASE_TSS.2, ALC_FLR.1	Common Criteria
valid until:	12 September 2028	

The IT Product identified in this certificate has been evaluated at an approved evaluation facility using the Common Methodology for IT Security Evaluation (CEM), Version 3.1 extended by Scheme Interpretations by advice of the Certification Body for components beyond EAL 5 and CC Supporting Documents as listed in the Certification Report for conformance to the Common Criteria for IT Security Evaluation (CC), Version 3.1. CC and CEM are also published as ISO/IEC 15408 and ISO/IEC 18045.

(*) This certificate applies only to the specific version and release of the product in its evaluated configuration and in conjunction with the complete Certification Report and Notification. For details on the validity see Certification Report part A chapter 5.

The evaluation has been conducted in accordance with the provisions of the certification scheme of the German Federal Office for Information Security (BSI) and the conclusions of the evaluation facility in the evaluation technical report are consistent with the evidence adduced.

This certificate is not an endorsement of the IT Product by the Federal Office for Information Security or any other organisation that recognises or gives effect to this certificate, and no warranty of the IT Product by the Federal Office for Information Security or any other organisation that recognises or gives effect to this certificate, is either expressed or implied.

Bonn, 13 September 2023

For the Federal Office for Information Security





Common Criteria **Recognition Arrangement** recognition for components up to EAL 2 and ALC FLR only



Sandro Amendola Director-General

L.S.

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A. Certification

1. **Preliminary Remarks**

Under the BSIG¹ Act, the Federal Office for Information Security (BSI) has the task of issuing certificates for information technology products.

Certification of a product is carried out on the instigation of the vendor or a distributor, hereinafter called the sponsor.

A part of the procedure is the technical examination (evaluation) of the product according to the security criteria published by the BSI or generally recognised security criteria.

The evaluation is normally carried out by an evaluation facility recognised by the BSI or by BSI itself.

The result of the certification procedure is the present Certification Report. This report contains among others the certificate (summarised assessment) and the detailed Certification Results.

The Certification Results contain the technical description of the security functionality of the certified product, the details of the evaluation (strength and weaknesses) and instructions for the user.

2. Specifications of the Certification Procedure

The certification body conducts the procedure according to the criteria laid down in the following:

- Act on the Federal Office for Information Security¹
- BSI Certification and Approval Ordinance²
- BMI Regulations on Ex-parte Costs ³
- Special decrees issued by the Bundesministerium des Innern und für Heimat (Federal Ministry of the Interior and Community)
- DIN EN ISO/IEC 17065 standard
- BSI certification: Scheme documentation describing the certification process (CC-Produkte) [3]
- BSI certification: Scheme documentation on requirements for the Evaluation Facility, its approval and licencing process (CC-Stellen) [3]
- Common Criteria for IT Security Evaluation (CC), Version 3.1⁴[1] also published as ISO/IEC 15408
- ¹ Act on the Federal Office for Information Security (BSI-Gesetz BSIG) of 14 August 2009, Bundesgesetzblatt I p. 2821
- Ordinance on the Procedure for Issuance of Security Certificates and approval by the Federal Office for Information Security (BSI-Zertifizierungs- und -Anerkennungsverordnung - BSIZertV) of 17 December 2014, Bundesgesetzblatt 2014, part I, no. 61, p. 2231
- ³ BMI Regulations on Ex-parte Costs Besondere Gebührenverordnung des BMI für individuell zurechenbare öffentliche Leistungen in dessen Zuständigkeitsbereich (BMIBGebV), Abschnitt 7 (BSI-Gesetz) - dated 2 September 2019, Bundesgesetzblatt I p. 1365

- Common Methodology for IT Security Evaluation (CEM), Version 3.1 [2] also published as ISO/IEC 18045
- BSI certification: Application Notes and Interpretation of the Scheme (AIS) [4]

3. **Recognition Agreements**

In order to avoid multiple certification of the same product in different countries a mutual recognition of IT security certificates - as far as such certificates are based on ITSEC or CC - under certain conditions was agreed.

3.1. European Recognition of CC – Certificates (SOGIS-MRA)

The SOGIS-Mutual Recognition Agreement (SOGIS-MRA) Version 3 became effective in April 2010. It defines the recognition of certificates for IT-Products at a basic recognition level and, in addition, at higher recognition levels for IT-Products related to certain SOGIS Technical Domains only.

The basic recognition level includes Common Criteria (CC) Evaluation Assurance Levels EAL 1 to EAL 4. For "Smartcards and similar devices" a SOGIS Technical Domain is in place. For "HW Devices with Security Boxes" a SOGIS Technical Domains is in place, too. In addition, certificates issued for Protection Profiles based on Common Criteria are part of the recognition agreement.

The current list of signatory nations and approved certification schemes, details on recognition, and the history of the agreement can be seen on the website at <u>https://www.sogis.eu</u>.

The SOGIS-MRA logo printed on the certificate indicates that it is recognised under the terms of this agreement by the related bodies of the signatory nations. A disclaimer beneath the logo indicates the specific scope of recognition.

This certificate is recognized under SOGIS-MRA for all assurance components selected.

3.2. International Recognition of CC – Certificates (CCRA)

The international arrangement on the mutual recognition of certificates based on the CC (Common Criteria Recognition Arrangement, CCRA-2014) has been ratified on 08 September 2014. It covers CC certificates based on collaborative Protection Profiles (cPP) (exact use), CC certificates based on assurance components up to and including EAL 2 or the assurance family Flaw Remediation (ALC_FLR) and CC certificates for Protection Profiles and for collaborative Protection Profiles (cPP).

The current list of signatory nations and approved certification schemes can be seen on the website: <u>https://www.commoncriteriaportal.org</u>.

The Common Criteria Recognition Arrangement logo printed on the certificate indicates that this certification is recognised under the terms of this agreement by the related bodies of the signatory nations. A disclaimer beneath the logo indicates the specific scope of recognition.

This certificate is recognized according to the rules of CCRA-2014, i. e. up to and including CC part 3 EAL 2+ ALC_FLR components.

⁴ Proclamation of the Bundesministerium des Innern und für Heimat of 12 February 2007 in the Bundesanzeiger dated 23 February 2007, p. 3730

4. Performance of Evaluation and Certification

The certification body monitors each individual evaluation to ensure a uniform procedure, a uniform interpretation of the criteria and uniform ratings.

The product NXP Secure Smart Card Controller N7122 with IC Dedicated Software and Crypto Library (R1/R2/R3) has undergone the certification procedure at BSI. This is a recertification based on BSI-DSZ-CC-1149-2022. Specific results from the evaluation process BSI-DSZ-CC-1149-2022 were re-used.

The evaluation of the product NXP Secure Smart Card Controller N7122 with IC Dedicated Software and Crypto Library (R1/R2/R3) was conducted by TÜV Informationstechnik GmbH. The evaluation was completed on 1 September 2023. TÜV Informationstechnik GmbH is an evaluation facility (ITSEF)⁵ recognised by the certification body of BSI.

For this certification procedure the sponsor and applicant is: NXP Semiconductors Germany GmbH.

The product was developed by: NXP Semiconductors Germany GmbH.

The certification is concluded with the comparability check and the production of this Certification Report. This work was completed by the BSI.

5. Validity of the Certification Result

This Certification Report applies only to the version of the product as indicated. The confirmed assurance package is valid on the condition that

- all stipulations regarding generation, configuration and operation, as given in the following report, are observed,
- the product is operated in the environment described, as specified in the following report and in the Security Target.

For the meaning of the assurance components and assurance levels please refer to CC itself. Detailed references are listed in part C of this report.

The Certificate issued confirms the assurance of the product claimed in the Security Target at the date of certification. As attack methods evolve over time, the resistance of the certified version of the product against new attack methods needs to be re-assessed. Therefore, the sponsor should apply for the certified product being monitored within the assurance continuity program of the BSI Certification Scheme (e.g. by a re-assessment or re-certification). Specifically, if results of the certification are used in subsequent evaluation and certification procedures, in a system integration process or if a user's risk management needs regularly updated results, it is recommended to perform a reassessment on a regular e.g. annual basis.

In order to avoid an indefinite usage of the certificate when evolved attack methods would require a re-assessment of the products resistance to state of the art attack methods, the maximum validity of the certificate has been limited. The certificate issued on 13 September 2023 is valid until 12 September 2028. Validity can be re-newed by recertification.

The owner of the certificate is obliged:

⁵ Information Technology Security Evaluation Facility

- 1. when advertising the certificate or the fact of the product's certification, to refer to the Certification Report as well as to provide the Certification Report, the Security Target and user guidance documentation mentioned herein to any customer of the product for the application and usage of the certified product,
- 2. to inform the Certification Body at BSI immediately about vulnerabilities of the product that have been identified by the developer or any third party after issuance of the certificate,
- 3. to inform the Certification Body at BSI immediately in the case that security relevant changes in the evaluated life cycle, e.g. related to development and production sites or processes, occur, or the confidentiality of documentation and information related to the Target of Evaluation (TOE) or resulting from the evaluation and certification procedure where the certification of the product has assumed this confidentiality being maintained, is not given any longer. In particular, prior to the dissemination of confidential documentation and information related to the TOE or resulting from the evaluation and certification procedure that do not belong to the deliverables according to the Certification Report part B, or for those where no dissemination rules have been agreed on, to third parties, the Certification Body at BSI has to be informed.

In case of changes to the certified version of the product, the validity can be extended to the new versions and releases, provided the sponsor applies for assurance continuity (i.e. re-certification or maintenance) of the modified product, in accordance with the procedural requirements, and the evaluation does not reveal any security deficiencies.

6. Publication

The product NXP Secure Smart Card Controller N7122 with IC Dedicated Software and Crypto Library (R1/R2/R3) has been included in the BSI list of certified products, which is published regularly (see also Internet: <u>https://www.bsi.bund.de</u> and [5]). Further information can be obtained from BSI-Infoline +49 228 9582-111.

Further copies of this Certification Report can be requested from the developer⁶ of the product. The Certification Report may also be obtained in electronic form at the internet address stated above.

⁶ NXP Semiconductors Germany GmbH Beiersdorfstraße 12 22529 Hamburg

B. Certification Results

The following results represent a summary of

- the Security Target of the sponsor for the Target of Evaluation,
- the relevant evaluation results from the evaluation facility, and
- complementary notes and stipulations of the certification body.

1. Executive Summary

The TOE is the hard macro "NXP Secure Smart Card Controller N7122 with IC Dedicated Software and Crypto Library (R1/R2/R3)", or in short "N7122", which is manufactured by GlobalFoundries 40nm (C40) technology and comprises of hardware, software (security IC Dedicated Software), and documentation. The N7122 is self-sufficient at the boundary of the hard macro and can be instantiated within packaged products. The TOE does not include a customer-specific Security IC Embedded Software, however, it provides secure mechanisms for customers to download and execute their code on the TOE.

The IC Dedicated Software comprises IC Dedicated Test Software for test purposes and IC Dedicated Support Software. The IC Dedicated Support Software consists of the Boot Software, which controls the boot process of the hardware platform, and a Firmware Interface. The IC Dedicated Support Software also comprises the following optional software components:

- a Library Interface, which simplifies the access to the hardware for the Security IC Embedded Software,
- a Flash Loader OS, which supports the download of code and data to the Flash by the Composite Product Manufacturer before Operational Usage (e.g. during development), and
- a Crypto Library, which provides simplified access to the frequently used cryptographic algorithms AES, TDES, RNG, RSA, ECC, hashing and utilities.

The Security Target [6] is the basis for this certification. It is based on the certified Protection Profile Security IC Platform Protection Profile with Augmentation Packages Version 1.0, 13 January 2014, BSI-CC-PP-0084-2014 [8].

The TOE Security Assurance Requirements (SAR) are based entirely on the assurance components defined in Part 3 of the Common Criteria (see part C or [1], Part 3 for details). The TOE meets the assurance requirements of the Evaluation Assurance Level EAL 6 augmented by ASE_TSS.2, ALC_FLR.1.

The TOE Security Functional Requirements (SFR) relevant for the TOE are outlined in the Security Target [6] and [9], chapter 6. They are selected from Common Criteria Part 2 and some of them are newly defined. Thus the TOE is CC Part 2 extended.

The TOE Security Functional Requirements are implemented by the following TOE Security Functionality:

TOE Security Functionality	Addressed issue
TSF.Service	Service functionalities apart from cryptographic operation
TSF.Protection	General security measures to protect the TSF
TSF.Control	Operating conditions, memory and hardware access control
TSF.Crypto	Cryptographic Services

Table 1: TOE Security Functionalities

For more details please refer to the Security Target [6] and [9], chapter 6.1.

The assets to be protected by the TOE are defined in the Security Target [6] and [9], chapter 3.1. Based on these assets the TOE Security Problem is defined in terms of

Assumptions, Threats and Organisational Security Policies. This is outlined in the Security Target [6] and [9], chapter 3.2 to 3.4.

This certification covers the configurations of the TOE as outlined in chapter 8.

The vulnerability assessment results as stated within this certificate do not include a rating for those cryptographic algorithms and their implementation suitable for encryption and decryption (see BSIG Section 9, Para. 4, Clause 2).

The certification results only apply to the version of the product indicated in the certificate and on the condition that all the stipulations are kept as detailed in this Certification Report. This certificate is not an endorsement of the IT product by the Federal Office for Information Security (BSI) or any other organisation that recognises or gives effect to this certificate, and no warranty of the IT product by BSI or any other organisation that recognises or gives effect to this certificate, is either expressed or implied.

2. Identification of the TOE

The Target of Evaluation (TOE) is called:

NXP Secure Smart Card Controller N7122 with IC Dedicated Software and Crypto Library (R1/R2/R3)

The following table outlines the TOE deliverables:

Туре	Name	Release	Form of delivery
TOE compone	nts for all configurations	1	
IC Hardware	N7122	A1	Hard macro instantiated within a wafer, module and/or package.
Document	NXP Secure Smart Card Controller N7122 – Overview, Product data sheet [11]	0.1 / 2021-03-31	Electronic document (PDF via NXP DocStore).
Document	NXP Secure Smart Card Controller N7122 – Instruction Set Manual, Product data sheet addendum [12]	0.2 / 2021-03-29	Electronic document (PDF via NXP DocStore).
Document	NXP Secure Smart Card Controller N7122 – Chip health mode, Product data sheet addendum [13]	0.2 / 2021-03-29	Electronic document (PDF via NXP DocStore).
Document	NXP Secure Smart Card Controller N7122 – Peripheral Configuration and Use Product data sheet addendum [14]	0.2 / 2021-04-12	Electronic document (PDF via NXP DocStore).
Document	NXP Secure Smart Card Controller N7122 – MMU Configuration and NXP Firmware Interface Specification, Product data sheet addendum [15]	1.0 / 2023-03-16	Electronic document (PDF via NXP DocStore).
Document	NXP N7122 A1 Hardmacro – Lifecycle Documentation, Report [16]	0.2 / 2022-02-04	Electronic document (PDF via NXP DocStore).
Document	NXP Secure Smart Card Controller N7122 – Shared OS Libraries [17]	0.4 / 2022-02-10	Electronic document (PDF via NXP DocStore).

Document	NXP Secure Smart Card Controller N7122 – Wafer and delivery specification [18]	1.2 / 2023-05-12	Electronic document (PDF via NXP DocStore).
Document	NXP Secure Smart Card Controller N7122, Information on Guidance and Operation, Guidance and operation manual [19]	1.3 / 2022-02-08	Electronic document (PDF via NXP DocStore).
Deliverables sp	pecific to COS-ROM configuration		
IC Dedicated Test Software	Test Software	11.6.5	On-chip software.
IC Dedicated	Boot Software	11.6.5	On-chip software.
Support Software	Firmware	11.6.5	On-chip software.
connaro	Library Interface	11.6.5	On-chip software.
	Flashloader OS	1.3.3	On-chip software.
Library	Communication Library	7.10.3	On-chip software.
Library	CRC Library	1.1.8	On-chip software.
Library	Memory Library	1.2.3.1	On-chip software.
Library	Flash Loader Library	3.10.0	On-chip software.
Document	NXP Secure Smart Card Controller N7122 – Flashloader OS, Product data sheet addendum [20]	0.4 / 2022-02-10	Electronic document (PDF via NXP DocStore).
Deliverables sp	pecific to NOS-ROM configuration		
IC Dedicated Test Software	Test Software	11.6.5	On-chip software.
IC Dedicated	Boot Software	11.6.5	On-chip software.
Support Software	Firmware	11.6.5	On-chip software.
Conware	Library Interface	11.6.5	On-chip software.
Library	Communication Library	7.10.2	On-chip software.
Library	CRC Library	1.1.8	On-chip software.
Library	Memory Library	1.2.3.1	On-chip software.
Deliverables of	the Crypto Library		
IC Dedicated Support Software	Crypto Library	1.1.2	On-chip software.
TOE componer	nts required for all packages		
Document	N7122 Crypto Library, Information on Guidance and Operation, User manual [21]	1.3 / 2022-03-16	Electronic document (PDF via NXP DocStore).
Package Rando	om Number Generation		
Library	RNG Lib	1.1.2	Electronic files (object files via NXP DocStore).
Library	RNG HealthTest Lib	1.1.2	Electronic files (object files via NXP DocStore).

		1	1
Document	N7122 Crypto Library – RNG Library, User manual [22]	1.1 / 2020-08-24	Electronic document (PDF via NXP DocStore).
Package Symm	netric Ciphers		
Library	Sym. Cipher Lib	1.1.2	Electronic files (object files via NXP DocStore).
Document	N7122 Crypto Library – SymCfg User manual [23]	1.1 / 2020-08-24	Electronic document (PDF via NXP DocStore).
Package KeyS	tore		
Library	KeyStoreMgr Lib	1.1.2	Electronic files (object files via NXP DocStore).
Document	N7122 Crypto Library – KeyStoreMgr, User manual Preliminary user manual [24]	1.1 / 2020-08-24	Electronic document (PDF via NXP DocStore).
TOE compone Ciphers	ents required for the packages Ran	dom Number Ger	neration and Symmetric
Library	Sym. Utilities Lib	1.1.2	Electronic files (object files via NXP DocStore).
Document	N7122 Crypto Library – Utils, User manual [25]	1.1 / 2020-08-24	Electronic document (PDF via NXP DocStore).
Package RSA	Encryption / Decryption		
Library	RSA Lib	1.1.2	Electronic files (object files via NXP DocStore).
Document	N7122 Crypto Library – RSA, User manual [26]	1.2 / 2020-08-24	Electronic document (PDF via NXP DocStore).
Package RSA	Key Generation		-
Library	RSA Key Generation Lib	1.1.2	Electronic files (object files via NXP DocStore).
Document	N7122 Crypto Library – RSA Key Generation, User Manual [27]	1.2 / 2020-08-24	Electronic document (PDF via NXP DocStore).
Package ECC	over GF(p)		
Library	ECC Lib	1.1.2	Electronic files (object files via NXP DocStore).
Document	N7122 Crypto Library – ECC over GF(p), User manual [28]	1.2 / 2020-08-24	Electronic document (PDF via NXP DocStore).
Package SHA			
Library	SHA Library & Hash Library	1.1.2	Electronic files (object files via NXP DocStore).
Document	N7122 Crypto Library – SHA, User manual [29]	1.1 / 2020-08-24	Electronic document (PDF via NXP DocStore).

Document	N7122 Crypto Library – HASH, User manual [30]	1.1 / 2020-08-24	Electronic document (PDF via NXP DocStore).
	ents required for the packages R C over GF(p), and SHA	SA Encryption /	Decryption, RSA Key
Library	Asym. Utilities Lib	1.1.2	Electronic files (object files via NXP DocStore).
Document	N7122 Crypto Library – UtilsAsym, User manual [31]	1.1 / 2020-08-24	Electronic document (PDF via NXP DocStore).
Package KoreanSeed (non TSF)			
Library	KoreanSeed Lib	1.1.2	Electronic files (object files via NXP DocStore).
Document	N7122 Crypto Library – KoreanSeed, User Manual [32]	1.1 / 2020-09-28	Electronic document (PDF via NXP DocStore).

Table 2: TOE deliverables

The TOE can be delivered in three different release packages: R1, R2, R3. These are explained in [6] and [9] chapter 1.4.1. The release packages are identical in the hard macro related functionalities of the TOE, but differ in the instantiation specific functionalities which are needed for the packaged product to integrate the hard macro. The differences are only minor functional modifications of the IC Dedicated Software without impact on the security functionalities of the TOE. Release packages R1 and R2 are manufactured at GlobalFoundries Fab 7 in Singapore. Release package R3 is manufactured at GlobalFoundries Fab 1 in Dresden.

The different release packages can be identified by Wafer Test ID, Firmware Extension ID, and Manufacturer ID using the GetVersion firmware command.

Release Package	Wafer Test ID	Firmware Extension ID	Manufacturer ID
R1	0x0F	0x06	0x7A
R2	0x10	0x07	0x7A
R3	0x0F	0x06	0x79
	0x10	0x07	0x79

Table 3: TOE deliverables

For more information refer to [15] chapter 4.1.3.2.

The hardware version can be identified (optical identification) by its die inscription as described in [18] chapter 2.9. Logical identification of the TOE is done via the firmware function phfwSystem_GetVersion. The same data can be accessed via Chip Health Mode, see [13] chapter 3.3.

3. Security Policy

The Security Policy is expressed by the set of Security Functional Requirements and implemented by the TOE. It covers the following issues: The Security Policy of the TOE is to provide basic security functionalities to be used by the smart card operating system and the smart card application thus providing an overall smart card system security. Therefore,

the TOE will implement symmetric and asymmetric cryptographic algorithms to ensure the confidentiality of plain text data by encryption and to support secure authentication protocols and it will provide a True Random Number Generator (TRNG) and Deterministic Random Number Generator (DRNG).

As the TOE is a hardware security platform, the security policy of the TOE is also to provide protection against leakage of information (e.g. to ensure the confidentiality of cryptographic keys during cryptographic functions performed by the TOE), against physical probing, against malfunctions, against physical manipulations and against abuse of functionality. Hence, the TOE shall

- maintain the integrity and the confidentiality of data stored in the memory of the TOE, and
- maintain the integrity, the correct operation and the confidentiality of security functionalities (security mechanisms and associated functions) provided by the TOE.

Specific details concerning the above mentioned security policies can be found in the Security Target [6] and [9] chapter 7.

4. Assumptions and Clarification of Scope

The Assumptions defined in the Security Target and some aspects of Threats and Organisational Security Policies are not covered by the TOE itself. These aspects lead to specific security objectives to be fulfilled by the TOE-Environment. The following topics are of relevance: OE.Resp-Appl, OE.Process-Sec-IC, OE.Lim_Block_Loader, OE.Loader_Usage and OE.Check_Init. Details can be found in the Security Target [6] and [9], chapter 4.2 and 4.3.

5. Architectural Information

The IC hardware is a microcontroller incorporating a central processing unit (CPU), memories accessible via a Memory Management Unit (MMU), cryptographic coprocessors, other security components, contact-based and contactless communication interfaces as well as a general purpose I/O interface which can be used to directly use peripherals of the TOE such as the cryptographic coprocessors. The central processing unit supports a 32-/16-bit instruction set optimized for smart card applications. On-chip memories are ROM, RAM and Flash. The Flash can be used as data or program memory. It consists of highly reliable memory cells, which are designed to provide data integrity. The Flash memory is optimized for applications that require reliable non-volatile data storage for data and program code. Dedicated security functionality protects the contents of all memories. The logical Flash size can be configured in 1kB steps. The IC integrates coprocessors for AES, DES (both within the new Crypto2+ coprocessor) and a new 128 bit Public Key Crypto Coprocessor (Fame3) to support the implementation of asymmetric cryptographic algorithms.

The IC Dedicated Software comprises IC Dedicated Test Software for test purposes and IC Dedicated Support Software. The IC Dedicated Support Software consists of the Boot Software, which controls the boot process of the hardware platform. Furthermore, it provides a Firmware Interface and optionally a Library Interface, simplifying access to the hardware for the Security IC Embedded Software. The IC Dedicated Support Software also comprises optional software components, i.e.,

- a Flash Loader OS which supports download of code and data to Flash by the Composite Product Manufacturer before Operational Usage (e.g. during development), and
- a Crypto Library which provides simplified access to frequently used cryptographic algorithms AES, TDES, RNG, RSA and ECC.

The availability of these software components depends on the different TOE configurations.

6. Documentation

The evaluated documentation as outlined in table 2 is being provided with the product to the customer. This documentation contains the required information for secure usage of the TOE in accordance with the Security Target.

Additional obligations and notes for secure usage of the TOE as outlined in chapter 10 of this report have to be followed.

7. IT Product Testing

7.1. Developer's Test according to ATE_FUN

Testing approach:

- All TSF and related security mechanisms, subsystems and modules are tested in order to assure complete coverage of all SFR.
- Different classes of tests are performed to test the TOE in a sufficient manner:
 - System Verification:

Test cases that can not be performed at module level are defined and implemented for system verification. This includes mainly the startup behaviour, system interoperability, endurance, and system security.

• Functional Module Verification:

This test category is used to verify the correct functionality of each of the individual modules that make up the TOE. It includes the following test groups:

- Positive Testing: Tests that are based on the requirement specification and the expected usage by the customer.
- Negative Testing: Tests that extend the scope of the intended usage of the TOE, assuming a misuse by the user.
- The tests are run with all possible system configurations.
- Security Verification: This test category addresses the security mechanisms described in the Security Architecture description. Two main categories of security module verification are defined:
 - Integrity Protection Module Verification (fault injection) using whitebox and blackbox testing.
 - DPA module verification (side-channel analysis).
- Characterization:

This mostly addresses production tests to measure varying parameters in postsilicon verification while all parameters are within the specified limits. The developer performs a Matrix Characterization Run to measure parameters using varying processes (corner material) and different temperatures.

• Qualification:

This test category ensures that a developed IC is production ready and has the expected quality. This addresses

- Electrostatic discharge due to electrostatic stress in the field (contactless communication),
- Fast aging of the device due to high temperatures to guarantee the life time of the product,
- Flash qualification to ensure that features like anti-tearing and wear levelling work as specified,
- Package qualification to ensure that the IC can be placed in the final delivery form (package) under industrial environments and the final product quality is achieved, and
- PUF qualification to ensure that the promised PUF properties hold in field conditions.
- Validation:

Execution of all customer-visible use cases to ensure that the entire system works as defined for customer-visible operation. This includes

• on-chip test framework developed to use each officially released product variant and execute each public available API.

7.2. Independent Testing according to ATE_IND

Testing approach:

- The evaluator's objective regarding this aspect was to test the functionality of the TOE as described in the ST and to verify the developer's test results by repeating developer's tests and additionally add independent tests.
- In the course of the evaluation of the TOE the following classes of tests were carried out:
 - Module tests,
 - Simulation tests,
 - Tests in User Mode of logical card B,
 - Tests in System Mode of card B,
 - Tests in Test Mode,
 - Hardware tests, and
 - Cryptographic library tests.

With this kind of tests the entire security functionality of the TOE was tested.

7.3. Penetration Testing according to AVA_VAN

Overview:

- The penetration testing was partially performed using the developer's testing environment, partially using the test environment of the evaluation body.
- All configurations of the TOE being intended to be covered by the current evaluation were tested.
- The overall test result is that no deviations were found between the expected and the actual test results; moreover, no attack scenario with the attack potential high was actually successful.

Penetration testing approach:

- Systematic search for potential vulnerabilities and known attacks in public domain sources, use of a list of vulnerabilities, and from a methodical analysis of the evaluation documents.
- Analysis why these vulnerabilities are unexploitable in the intended environment of the TOE.
- If the rationale is suspect in the opinion of the evaluator penetration tests are devised.

Even if the rational is convincing in the opinion of the evaluator penetration tests are devised for some vulnerabilities, especially to support the argument of non-practicability of exploiting time in case of SPA, DPA and FI attacks.

8. Evaluated Configuration

The TOE can be delivered with various configuration options as described in chapter 1.4.1 of [6] and [9] and shown in the following table. Of these, only one option (COS-ROM) is available to external customers. The other option (NOS-ROM) is only available for NXP internal use.

Description
The TOE provides the functionality of a Flash Loader such that customers can load their Security IC Embedded Software Code to the NVM memory.
If the Flash Loader is available, the Library Interface and the N7122 Crypto Library become mandatory.
All libraries given in Table 2 will be stored to ROM.
The Security IC Embedded Software will be stored in Flash.
Note:
The TOE does not provide a NXP System Mode OS.
The TOE does not provide the functionality of a Flash Loader.
The Security IC Embedded Software will be stored in ROM.
The Libraries given in Table 2 will be stored to either ROM or Flash.
Note:
This option is available for NXP internal use only.

Table 4: : TOE Major Configuration Options

The following table shows the size of the TOE's memories:

Memory type	Memory size	Description
NVM	Configurable in 1 KB steps up to 633.5 KB	The size of the Non-Volatile Memory.
ROM	Configurable to 0 KB or 219 KB	Size of the Read-Only Memory.
RAM	Up to 12.5 KB	Size of the Random-Access Memory. Size available to customer depends on ordered configuration.

Table 5: TOE memory configuration limits

In chapter 1.4.1 of [6] and [9], the developer describes that TOE configurations can be applied during the ordering process. The following table lists these Ordering configurations.

Product option	Choices	Description
NVM size	Configurable in 1KB steps up to 633,5 KB	The Flash memory size is logically configurable, within the given step size.

Table 6: TOE configuration options

Other TOE configurations are listed in [6] and [9] as well. They address different options for communication interfaces or the availability of the chip health mode, which can be used for TOE identification.

9. **Results of the Evaluation**

9.1. CC specific results

The Evaluation Technical Report (ETR) [7] was provided by the ITSEF according to the Common Criteria [1], the Methodology [2], the requirements of the Scheme [3] and all interpretations and guidelines of the Scheme (AIS) [4] as relevant for the TOE.

The Evaluation Methodology CEM [2] was used for those components up to EAL 5 extended by advice of the Certification Body for components beyond EAL 5 and guidance specific for the technology of the product [4] (AIS 34).

The following guidance specific for the technology was used:

- (i) The Application of CC to Integrated Circuits
- (ii) Application of Attack Potential to Smartcards
- (iii) Guidance, Smartcard Evaluation

(see [4], AIS 25, AIS 37).

For RNG assessment the scheme interpretations AIS 31 and AIS 20 were used (see [4]).

To support composite evaluations according to AIS 36 the document ETR for composite evaluation [10] was provided and approved. This document provides details of this platform evaluation that have to be considered in the course of a composite evaluation on top.

As a result of the evaluation the verdict PASS is confirmed for the following assurance components:

- All components of the EAL 6 package including the class ASE as defined in the CC (see also part C of this report)
- The components ASE_TSS.2, ALC_FLR.1 augmented for this TOE evaluation.

As the evaluation work performed for this certification procedure was carried out as a reevaluation based on the certificate BSI-DSZ-CC-1149-2022, re-use of specific evaluation tasks was possible. The focus of this re-evaluation was on the inclusion of the Site Global Foundries Dresden (Fab 1), which is added to the production flow as second source for wafer production. The user guidance was updated to provide identification information for the new Wafer Fab.

The evaluation has confirmed:

 PP Conformance: 	Security IC Platform Protection Profile with Augmentation Packages Version 1.0, 13 January 2014, BSI-CC-PP-0084-2014 [8]
 for the Functionality: 	PP conformant plus product specific extensions Common Criteria Part 2 extended
 for the Assurance: 	Common Criteria Part 3 conformant EAL 6 augmented by ASE_TSS.2, ALC_FLR.1

For specific evaluation results regarding the development and production environment see annex B in part D of this report.

The results of the evaluation are only applicable to the TOE as defined in chapter 2 and the configuration as outlined in chapter 8 above.

9.2. Results of cryptographic assessment

The strength of the cryptographic algorithms was not rated in the course of this certification procedure (see BSIG Section 9, Para. 4, Clause 2). But cryptographic functionalities with a security level of lower than 120 bits can no longer be regarded as secure without considering the application context. Therefore, for these functionalities it shall be checked whether the related crypto operations are appropriate for the intended system. Some further hints and guidelines can be derived from the 'Technische Richtlinie BSI TR-02102' (https://www.bsi.bund.de).

The following table gives an overview of the cryptographic functionalities inside the TOE to enforce the security policy and outlines its rating from cryptographic point of view. Any Cryptographic Functionality that is marked in column '*Security Level above 120 Bits*' of the following table with '*no*' achieves a security level of lower than 120 Bits (in general context) only.

No.	Purpose	Cryptographic Mechanism	Standard of Implementation	Key Size in Bits	Security Level above 120 Bits	
TOE	TOE Hardware/Firmware					
1	Cryptographic primitive	AES	[FIPS197]	128, 192, 256	Yes	
2	Confidentiality	AES encryption and decryption in ECB mode	[FIPS197] (AES), [NIST SP800-38A] (ECB)	128, 192 256	No	

No.	Purpose	Cryptographic Mechanism	Standard of Implementation	Key Size in Bits	Security Level above 120 Bits
3	Cryptographic primitive	Triple-DES	[NIST SP800-67]	168	No
4	Confidentiality	Triple-DES encryption and decryption in ECB mode	[NIST SP800-67] (TDES), [NIST SP800-38A] (ECB)	168	No
5	Confidentiality	AES encryption and decryption in CBC mode using PUF key	[FIPS197] (AES), [NIST SP800-38A] (CBC), [PUF]	128	Yes
6	Integrity	AES MAC generation and verification in CBC-MAC mode	[FIPS197] (AES), Algorithm 1 in [ISO_9797-1] (CBC-MAC), [PUF]	128	No
7	Key Derivation	Proprietary PUF key derivation	[PUF]	128	Not rated
8	Random number generation	PTG.2	Comformant to [AIS31]	N/A	N/A
TOE	Software(Crypt	o Library)			
9	Cryptographic primitive	AES	[FIPS197]	128, 192, 256	Yes
10	Confidentiality	AES encryption and decryption in CBC, OFB, and CTR mode	[FIPS197] (AES), [NIST SP800-38A] (CBC, OFB, CTR)	128, 192, 256	Yes
11	Integrity	AES MAC generation in CBC-MAC mode	[FIPS197] (AES), Algorithm 1 in [ISO_9797-1] (CBC-MAC)	128, 192, 256	No
12	Integrity	AES MAC generation in CMAC mode	[FIPS197] (AES), [NIST SP800-38B] (CMAC)	128, 192, 256	Yes
13	Cryptographic primitive	Triple-DES	[NIST SP800-67]	168	No
14	Confidentiality	Triple-DES encryption and decryption in CBC and OFB mode	[NIST SP800-67] (TDES), [NIST SP800-38A] (CBC, OFB)	168	No
15	Integrity	Triple-DES MAC generation in CBC- MAC and Retail-MAC	[NIST SP800-67] (TDES), Algorithm 1 in [ISO_9797-1] (CBC-MAC), Algorithm 3 in [ISO_9797-1] (CBC-MAC)	168	No
16	Integrity	Triple-DES MAC generation in CMAC mode	[NIST SP800-67] (TDES), [NIST SP800-38B] (CMAC)	168	No
17	Cryptographic	RSAEP, RSADP,	[PKCS #1]	512-1999	No

No.	Purpose	Cryptographic Mechanism	Standard of Implementation	Key Size in Bits	Security Level above 120 Bits
	primitive	RSASP1, RSAVP1			
18	Cryptographic primitive	RSAEP, RSADP, RSASP1, RSAVP1	[PKCS #1]	2000 - 2799	> 100 bits
19	Cryptographic primitive	RSAEP, RSADP, RSASP1, RSAVP1	[PKCS #1]	2800 - 4096	Yes
20	Confidentiality	RSA encryption and decryption with EME- OAEP encoding	[PKCS #1]	512 - 1999	No
21	Confidentiality	RSA encryption and decryption with EME- OAEP encoding	[PKCS #1]	2000 - 2799	> 100 bits
22	Confidentiality	RSA encryption and decryption with EME- OAEP encoding	[PKCS #1]	2800 - 4096	Yes
23	Cryptographic primitive	RSA signature generation and verification with EMSA-PSS encoding	[PKCS #1]	512 - 1999	No
24	Cryptographic primitive	RSA signature generation and verification with EMSA-PSS encoding	[PKCS #1]	2000 - 2799	> 100 bits
25	Cryptographic primitive	RSA signature generation and verification with EMSA-PSS encoding	[PKCS #1]	2800 - 4096	Yes
26	Key derivation	RSA derivation of public key from CRT private key	[AGD_CL_RSA, 4.4]	512 - 4096	N/A
27	Key generation	RSA key generation	[ALGO]	512 - 1999	No
28	Key generation	RSA key generation ⁷	[ALGO], [FIPS 186-4]	2000 - 2799	> 100 bits
29	Key generation	RSA key generation ⁷	[ALGO], [FIPS 186-4]	2800- 4096	Yes
30	Cryptographic primitive	ECDSA signature generation and verification	on and [ANS X9.62], [FIPS186-4],		No
31	Cryptographic	ECDSA signature	[ISO_14888-3],	256, 320,	Yes

⁷For the modulus n (n = p^*q) the prime numbers p and q generated by the key generator are congruent to 3 modulo 4

No.	Purpose	Cryptographic Mechanism	Standard of Implementation	Key Size in Bits	Security Level above 120 Bits	
	primitive	generation and verification	[ANS X9.62], [FIPS186-4], [IEEE_P1363]	384, 512, 521		
32	Key Exchange	ECDH	[ISO_11770-3], [ANS X9.62], [IEEE_P1363]	224	No	
33	Key Exchange	ECDH	[ISO_11770-3], [ANS X9.62], [IEEE_P1363]	256, 320, 384, 512, 521	Yes	
34	Key generation	ECDSA Key Generation	[ISO_14888-3], [ANS X9.62], [FIPS186-4]	224	No	
35	Key generation	ECDSA Key Generation	[ISO_14888-3], [ANS X9.62], [FIPS186-4]	256, 320, 384, 512, 521	Yes	
36	Cryptographic primitive	SHA-1	[FIPS180-4]	N/A	No	
37	Cryptographic primitive	SHA-224, SHA-256, SHA-384, SHA-512	[FIPS180-4]	N/A	Yes	
38	Random number generation	PTG.3 based AES or TDES in CTR mode	[FIPS197] (AES), [NIST SP800-67] (TDES), [NIST SP800-38A] (CTR), [NIST SP800-90A] (CTR_DRBG)	N/A	N/A	
			Conformant to [AIS20]			
39	Random number generation	DRG.4 based AES or TDES in CTR mode	[FIPS197] (AES), [NIST SP800-67] (TDES), [NIST SP800-38A] (CTR), [NIST SP800-90A] (CTR_DRBG)	N/A	N/A	
			Conformant to [AIS20]			
TOE	Software (Flash	n Loader)				
40	Authenticity	MAC verification with AES in CMAC mode	[FIPS197] (AES), [NIST SP800-38B] (CMAC)	128	Not rated	
41	Authentication	MAC generation and verification with AES in CMAC mode	[FIPS197] (AES), [NIST SP800-38B] (CMAC)	128	Not rated	
42	Key derivation	Key derivation using AES in CMAC mode as pseudo-random function	[FIPS197] (AES), [NIST SP800-38B] (CMAC), [NIST SP800-108] (KBKDF)	128	Not rated	
43	Confidentiality	Decryption with AES in CBC mode	[FIPS197] (AES), [NIST SP800-38A] (CBC)	128	Not rated	

Table 7: TOE cryptographic functionality

Please note that the IC Embedded Software is responsible for key handling. In this context, the key requirements of [NIST SP800-67] have to be considered.

[AGD_CL_RSA]	N7122 Crypto Library RSA, Version 1.2, 2020-08-24, NXP Germany.
[AIS20]	Anwendungsweise und Interpretationen zum Schema (AIS) – AIS 20, Funktionalitätsklassen und Evaluationsmethodologie für deterministische Zufallszahlengeneratoren, Version 3, 2013-05-15, Zertifizierungsstelle des BSI im Rahmen des Zertifizierungsschemas, Bundesamt für Sicherheit in der Informationstechnik.
[ANS X9.62]	Public Key Cryptography for the Financial Service Industry: The Elliptic Curve Digital Signature Algorithm (ECDSA), 2005-11-16, American National Standards Institute
[FIPS180-4]	Federal Information Processing Standard Publication 180-4, Secure Hash Standards (SHS), August 2015, National Institute of Standards and Technology
[FIPS186-4]	Federal Information Processing Standard Publication 186-4, Digital Signature Standards (DSS), July 2013, National Institute of Standards and Technology.
[FIPS197]	Federal Information Processing Standards Publication 197, Announcing the ADVANCED ENCRYPTION STANDARD (AES), 2001-11-26, National Institute of Standards and Technology (NIST).
[IEEE_P1363]	IEEE P1363. Standard specifications for public key cryptography. IEEE, 2000.
[ISO_9797-1]	ISO 9797-1: Information technology – Security techniques - Message Authentication Codes (MACs) - Part 1: Mechanisms using a block cipher, 1999-12, ISO/IEC
[ISO_11770-3]	ISO 11770-3: Information technology – Security techniques – Key management – Part 3: Mechanisms using asymmetric techniques, August 2015, ISO/IEC
[ISO_14888-3]	ISO/IEC 14888-3, IT Security techniques – Digital signatures with appendix – Part 3: Discrete logarithm based mechanisms, November 2018.
[NIST SP800-38A]	NIST Special Publication 800-38A 2001 Edition Recommendation for BlockCipher Modes of Operation Method and Techniques, National Institute of Standards and Technology (NIST), Technology Administration, U.S. Department of Commerce.
[NIST SP800-38B]	NIST Special Publication 800-38B, Recommendation for BlockCipher Modes of Operation: The CMAC Mode for Authentication, May 2005 National Institute of Standards and Technology.
[NIST SP800-67]	NIST Special Publication 800-67 –Revision 2, Recommendation for the Triple Data Encryption Algorithm (TDEA) Block Cipher – Revised July 2017, National Institute of Standards and Technology (NIST), Technology Administration, U.S. Department of Commerce
[NIST SP800-90A]	NIST SP 800-90A, A Deterministic Random Bit Generator Validation System (DRBGVS), 2015-10-29, National Institute of Standards and Technology.
[NIST SP800-108]	NIST SP 800-108, Recommendation for Key Derivation Using Pseudorandom Functions (Revised), October 2009, National Institute of Standards and Technology.
[PKCS #1]	PKCS #1: RSA Cryptography Standard, Version 2.1, 2002-06-14, RSA Laboratories.
[PUF]	PUF Key derivation function specification, 2014, NXP Semiconductors

10. Obligations and Notes for the Usage of the TOE

The documents as outlined in table 2 contain necessary information about the usage of the TOE and all security hints therein have to be considered. In addition all aspects of Assumptions, Threats and OSPs as outlined in the Security Target not covered by the TOE itself need to be fulfilled by the operational environment of the TOE.

The customer or user of the product shall consider the results of the certification within his system risk management process. In order for the evolution of attack methods and techniques to be covered, he should define the period of time until a re-assessment of the TOE is required and thus requested from the sponsor of the certificate.

The limited validity for the usage of cryptographic algorithms as outlined in chapter 9 has to be considered by the user and his system risk management process, too.

Some security measures are partly implemented in this certified TOE, but require additional configuration or control or measures to be implemented by a product layer on top, e.g. the IC Dedicated Support Software and/or Embedded Software using the TOE. For this reason the TOE includes guidance documentation (see table 2) which contains obligations and guidelines for the developer of the product layer on top on how to securely use this certified TOE and which measures have to be implemented in order to fulfil the security requirements of the Security Target of the TOE. In the course of the evaluation of the composite product or system it must be examined if the required measures have been correctly and effectively implemented by the product layer on top. Additionally, the evaluation of the documents "ETR for composite evaluation" [10] and Addendum to ETR for composite evaluation [33].

At the point in time when evaluation and certification results are reused there might be an update of the document "ETR for composite evaluation" available. Therefore, the certified products list on the BSI website has to be checked for latest information on reassessments, recertifications or maintenance result available for the product.

11. Security Target

For the purpose of publishing, the Security Target [9] of the Target of Evaluation (TOE) is provided within a separate document as Annex A of this report. It is a sanitised version of the complete Security Target [6] used for the evaluation performed. Sanitisation was performed according to the rules as outlined in the relevant CCRA policy (see AIS 35 [4]).

12. Regulation specific aspects (elDAS, QES)

None

13. Definitions

13.1. Acronyms

AIS	Application Notes and Interpretations of the Scheme		
BSI	Bundesamt für Sicherheit in der Informationstechnik / Federal Office for Information Security, Bonn, Germany		

BSIG BSI-Gesetz / Act on the Federal Office for Information Security

CCRA	Common Criteria Recognition Arrangement
CC	Common Criteria for IT Security Evaluation
CEM	Common Methodology for Information Technology Security Evaluation
сРР	Collaborative Protection Profile
EAL	Evaluation Assurance Level
ETR	Evaluation Technical Report
п	Information Technology
ITSEF	Information Technology Security Evaluation Facility
PP	Protection Profile
SAR	Security Assurance Requirement
SFP	Security Function Policy
SFR	Security Functional Requirement
ST	Security Target
TOE	Target of Evaluation
TSF	TOE Security Functionality

13.2. Glossary

Augmentation - The addition of one or more requirement(s) to a package.

Collaborative Protection Profile - A Protection Profile collaboratively developed by an International Technical Community endorsed by the Management Committee.

Extension - The addition to an ST or PP of functional requirements not contained in CC part 2 and/or assurance requirements not contained in CC part 3.

Formal - Expressed in a restricted syntax language with defined semantics based on wellestablished mathematical concepts.

Informal - Expressed in natural language.

Object - A passive entity in the TOE, that contains or receives information, and upon which subjects perform operations.

Package - named set of either security functional or security assurance requirements

Protection Profile - A formal document defined in CC, expressing an implementation independent set of security requirements for a category of IT Products that meet specific consumer needs.

Security Target - An implementation-dependent statement of security needs for a specific identified TOE.

Semiformal - Expressed in a restricted syntax language with defined semantics.

Subject - An active entity in the TOE that performs operations on objects.

Target of Evaluation - An IT Product and its associated administrator and user guidance documentation that is the subject of an Evaluation.

TOE Security Functionality - Combined functionality of all hardware, software, and firmware of a TOE that must be relied upon for the correct enforcement of the SFRs.

14. Bibliography

- [1] Common Criteria for Information Technology Security Evaluation, Version 3.1, Part 1: Introduction and general model, Revision 5, April 2017 Part 2: Security functional components, Revision 5, April 2017 Part 3: Security assurance components, Revision 5, April 2017 <u>https://www.commoncriteriaportal.org</u>
- [2] Common Methodology for Information Technology Security Evaluation (CEM), Evaluation Methodology, Version 3.1, Rev. 5, April 2017, <u>https://www.commoncriteriaportal.org</u>
- [3] BSI certification: Scheme documentation describing the certification process (CC-Produkte) and Scheme documentation on requirements for the Evaluation Facility, approval and licencing (CC-Stellen), <u>https://www.bsi.bund.de/zertifizierung</u>
- [4] Application Notes and Interpretations of the Scheme (AIS) as relevant for the TOE⁸ <u>https://www.bsi.bund.de/AIS</u>
- [5] German IT Security Certificates (BSI 7148), periodically updated list published also on the BSI Website, <u>https://www.bsi.bund.de/zertifizierungsreporte</u>
- [6] Security Target BSI-DSZ-CC-1149-V2-2023, NXP Secure Smart Card Controller N7122 with IC Dedicated Software and Crypto Library (R1/R2/R3), Version 1.6, 2023-06-26, NXP Semiconductors (confidential document)

⁸specifically

- AIS 1, Version 14, Durchführung der Ortsbesichtigung in der Entwicklungsumgebung des Herstellers
- AIS 14, Version 7, Anforderungen an Aufbau und Inhalt der ETR-Teile (Evaluation Technical Report) für Evaluation nach CC (Common Criteria)
- AIS 19, Version 9, Anforderungen an Aufbau und Inhalt der Zusammenfassung des ETR (Evaluation Technical Report) für Evaluationen nach CC (Common Criteria)
- AIS 20, Version 3, Funktionalitätsklassen und Evaluationsmethodologie für deterministische Zufallszahlengeneratoren
- AIS 25, Version 9, Anwendung der CC auf Integrierte Schaltungen including JIL Document and CC Supporting Document
- AIS 26, Version 10, Evaluationsmethodologie f
 ür in Hardware integrierte Schaltungen including JIL Document and CC Supporting Document
- AIS 31, Version 3, Funktionalitätsklassen und Evaluationsmethodologie für physikalische Zufallszahlengeneratoren
- AIS 32, Version 7, CC-Interpretationen im deutschen Zertifizierungsschema
- AIS 34, Version 3, Evaluation Methodology for CC Assurance Classes for EAL 5+ (CCv2.3 & CCv3.1) and EAL 6 (CCv3.1)
- AIS 35, Version 2, Öffentliche Fassung des Security Targets (ST-Lite) including JIL Document and CC Supporting Document and CCRA policies
- AIS 36, Version 5, Kompositionsevaluierung including JIL Document and CC Supporting Document
- AIS 38, Version 2, Reuse of evaluation results
- AIS 39, Version 3, Formal Methods
- AIS 46, Version 3, Informationen zur Evaluierung von kryptographischen Algorithmen und ergänzende Hinweise für die Evaluierung von Zufallszahlengeneratoren
- AIS 47, Version 1.1, Regelungen zu Site Certification

- [7] Evaluation Technical Report (ETR) for NXP Secure Smart Card Controller N7122 with IC Dedicated Software and Crypto Library (R1/R2/R3), BSI-DSZ-CC-1149-V2, Version 2, 2023-08-22, TÜV Informationstechnik GmbH.
- [8] Security IC Platform Protection Profile with Augmentation Packages Version 1.0, 13 January 2014, BSI-CC-PP-0084-2014
- [9] Security Target Lite BSI-DSZ-CC-1149-V2-2023, NXP Secure Smart Card Controller N7122 with IC Dedicated Software and Crypto Library (R1/R2R3), Version 1.6, 2023-06-26, NXP Semiconductors (sanitised public document)
- [10] Evaluation Technical Report for Composite Evaluation (ETR COMP) for NXP Secure Smart Card Controller N7122 with IC Dedicated Software and Crypto Library (R1/R2/R3), Version 3, 2022-05-10, TÜV Informationstechnik GmbH. (confidential document)
- [11] NXP Secure Smart Card Controller N7122 Overview Product data sheet, Version 0.1, 2021-03-31, NXP Semiconductors
- [12] NXP Secure Smart Card Controller N7122 Instruction Set Manual, Product data sheet addendum, Version 0.2, 2021-03-29, NXP Semiconductors
- [13] NXP Secure Smart Card Controller N7122 Chip health mode, Product data sheet addendum, Version 0.2, 2021-03-29, NXP Semiconductors
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- [17] NXP Secure Smart Card Controller N7122 Shared OS Libraries, Version 0.4, 2022-02-10, NXP Semiconductors
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- [29] N7122 Crypto Library SHA, User manual, Version 1.1, 2020-08-24, NXP Semiconductors
- [30] N7122 Crypto Library HASH, User manual, Version 1.1, 2020-08-24, NXP Semiconductors
- [31] N7122 Crypto Library UtilsAsym, User manual, Version 1.1, 2020-08-24, NXP Semiconductors
- [32] N7122 Crypto Library KoreanSeed, User Manual, Version 1.1, 2020-09-28, NXP Semiconductors
- [33] Addendum to EvaluationTechnical Report for Composite Evaluation (ETR COMP) BSI-DSZ-CC-1149-2022, Version 2, 2023-08-22, TÜVIT

C. Excerpts from the Criteria

For the meaning of the assurance components and levels the following references to the Common Criteria can be followed:

- On conformance claim definitions and descriptions refer to CC part 1 chapter 10.5
- On the concept of assurance classes, families and components refer to CC Part 3 chapter 7.1
- On the concept and definition of pre-defined assurance packages (EAL) refer to CC Part 3 chapters 7.2 and 8
- On the assurance class ASE for Security Target evaluation refer to CC Part 3 chapter 12
- On the detailed definitions of the assurance components for the TOE evaluation refer to CC Part 3 chapters 13 to 17
- The table in CC part 3 , Annex E summarizes the relationship between the evaluation assurance levels (EAL) and the assurance classes, families and components.

The CC are published at https://www.commoncriteriaportal.org/cc/

D. Annexes

List of annexes of this certification report

- Annex A: Security Target provided within a separate document.
- Annex B: Evaluation results regarding development and production environment

Annex B of Certification Report BSI-DSZ-CC-1149-V2-2023

Evaluation results regarding development and production environment



The IT product NXP Secure Smart Card Controller N7122 with IC Dedicated Software and Crypto Library (R1/R2/R3) (Target of Evaluation, TOE) has been evaluated at an approved evaluation facility using the Common Methodology for IT Security Evaluation (CEM), Version 3.1 extended by Scheme Interpretations by advice of the Certification Body for components beyond EAL 5 and CC Supporting Documents for conformance to the Common Criteria for IT Security Evaluation (CC), Version 3.1.

As a result of the TOE certification, dated 13 September 2023, the following results regarding the development and production environment apply. The Common Criteria assurance requirements ALC – Life cycle support (i.e. ALC_CMC.5, ALC_CMS.5, ALC_DEL.1, ALC_DVS.2, ALC_LCD.1, ALC_FLR.1 and ALC_TAT.3) are fulfilled for the development and production sites <u>of the TOE</u> listed below:

Name of site / Company name		Address		Function
Development Sites				
NXP Hamburg NXP Semic Troplowitzs 22529 Han Germany			data and prov supp pers deliv and	ect management, central design base, HW/FW/SW development verification, security architecture evaluation, flaw remediation, trust isioning, customer support, IT port, IC test and pre- onalization, key generation and rery, reliability test & failure analysis warehousing incl. scrapping, ment and delivery.
NXP Gratkorn NXP Semio Mikronweg 8101 Gratk Austria			deve arch	ect management, HW/FW/SW elopment and verification, security itecture and evaluation, and ument control system (DocStore).
Eindhoven HTC-46.3- Building 46 HTC-46.3-		west (Development Center) 5, High Tech Campus west 556AE, Eindhoven	arch	FW/SW development, security itecture. IT engineering and eric support.
NXP Nijmegen NXP Semio Gerstweg 2 6534AE Nij The Nether		jmegen		ication of design data and mask , sample preparation.
NXP Glasgow 2	NXP Glase	gow EK	Harc	dware development, security

	Pegasus House, Scottish Enterprise Technology Park, Bramah Ave East Kilbride, Glasgow G75 0RD Scotland, UK	architecture and reviews.
NXP Leuven	NXP Semiconductors Interleuvenlaan 80 B-3001 Leuven Belgium	Hardware development, security reviews.
Sii Gdansk 2	SII Olivia Prime Building, 10th floor, Grunwaldzka 472E 80-309 Gdansk Poland	SW development and verification.
NXP IT Eindhoven	NXP Master IT	NXP Master IT
Akquinet Datacenter Hamburg	Akquinet Datacenter Hamburg Ulzburger Strasse 201 22850 Norderstedt Germany	Data center.
Colt Datacenter Hamburg	Colt Datacenter Hamburg Obenhauptstrasse 22335 Hamburg Germany	Data center.
Digital Realty Phoenix	Digital Realty Data Center 120 E Van Buren St, Phoenix AZ 85004 U.S.A.	Data center.
Equinix Singapore	EQUINIX 20 Ayer Rajah Crescent, IBX SG1, Level 5 Unit 5, Ayer Rajah Industrial Park 139964 Singapore	Data center.
NXP Bangalore	NXP India Private Limited Manyata Technology Park, Nagawara Village, Kasaba Hobli Bangalore 560 045 India	Data center.
NXP Bucharest	NXP Semiconductors Romania Campus 6, Bulevardul Iuliu Maniu 6L, 061103 Bucureşti Romania	IT engineering and support.
NXP Guadalajara	NXP Guadalajara Periferico Sur #8110 Col. El Mante JALISCO, 45609 Tlaquepaque Mexico	IT engineering and support.
NXP Master IT	NXP Semiconductors HTC Building 60 High Tech Campus	Virtual IT Network and Administration site.

	5656 Eindhoven	
	Netherlands	
Production Sites		Γ
Global Foundries Singapore (Fab 7)	GlobalFoundries Singapore Pte Ltd 60 Woodlands Industrial Park D, Street 2 Singapore, 738406	Mask and wafer production.
Global Foundries Dresden (Fab 1) GlobalFoundries Fab 1 Dresden Wilschdorfer Landstrasse 101 01109 Dresden Germany		Mask and wafer production.
AMTC Dresden	Advanced Mask Technology Center GmbH & Co KG (AMTC) Rähnitzer Allee 9 01109 Dresden Germany	Wafer mask production.
	Toppan Photomasks Inc. 400 Texas Avenue Round Rock, TX 78664 USA	IT administration for AMTC Dresden.
Chipbond Hsinchu	Chipbond Technology Corporation No. 3, Li-Hsin Rd. V Science Based Industrial Park Hsin-Chu City Taiwan, R.O.C.	Bumping.
NXP Hamburg TC See NXP Hamburg		See NXP Hamburg.
NXP ATBK	NXP Semiconductors Thailand (ATBK) 303 Moo 3 Chaengwattana Rd., Laksi Bangkok 10210 Thailand	Test centre, wafer treatment, module assembly, (pre-) personalization, delivery, and test program engineering (TPE).
NXP ATKH	NXP Semiconductors Taiwan Ltd (ATKH) #10, Chin 5th Road, N.E.P.Z Kaohsiung 81170 Taiwan, R.O.C.	Test centre, wafer treatment, module assembly, (pre-) personalization, and delivery.
Linxens Thailand	Linxens Co., Ltd. 142 Moo, Hi-Tech Industrial Estate, Tambon Ban Laean, Amphor Bang Pa- In 13160 Ayutthaya Thailand	Inlay production.
HID Malaysia	HID Global Sdn. Bhd. No. 2, Jalan i-Park 1/1 Kawasan Perindustrian i-Park Bandar Indahpura 81000 Kulai, Johor Malaysia	Inlay production.

SIPI Chicago	Sipi Metals & Materials	Secure Scapping.
	1720 N. Elston Avenue Chicago, Illinois 60642-1579	
	United States	

Table 8: Relevant development/production sites

For the sites listed above, the requirements have been specifically applied in accordance with the Security Target [6]. The evaluators verified, that the threats, security objectives and requirements for the TOE life cycle phases up to delivery (as stated in the Security Target [6] and [9]) are fulfilled by the procedures of these sites.

Note: End of report